RENESAS

HD74LS190

Synchronous Up / Down Decade Counter (signal clock line)

REJ03D0452-0200 Rev.2.00 Jul.15.2005

Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

The outputs of the four master-slave flip-flops are triggered on a low-to-high-level transition of the clock input if the enable input is low. A high at the enable input inhibits counting. Level changes at the enable input should be made only when the clock input is high. The direction of the count is determined by the level of the down / up input. When low, the counter counts up and when high, it counts down. Level changes at the down / up input should be made only when the clock input is high. This counter is fully programmable; that is, the outputs may be preset to either level by placing a low on the load input and entering the desired data at the data inputs. The output will change to agree with the data inputs independently of the level of the clock input. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs. The clock, down / up, and load inputs are buffered to lower the drive requirement which significantly reduces the number of clock drivers, etc., required for long parallel words.

Two outputs have been made available to perform the cascading function: ripple clock and maximum / minimum count. The latter output produces a high-level output pulse with a duration approximately equal to one complete cycles to the clock when the counter overflows or underflows. The ripple clock output produces a low-level output pulse equal in width to the low-level portion of the clock input when an overflow or underflow conditions exists.

The counters can be easily cascaded by feeding the ripple clock output to the enable input of the succeeding counter if parallel clocking is used, or to the clock input if parallel enabling is used. The maximum / minimum count output can be used to accomplish look-ahead for high-speed operation.

Features

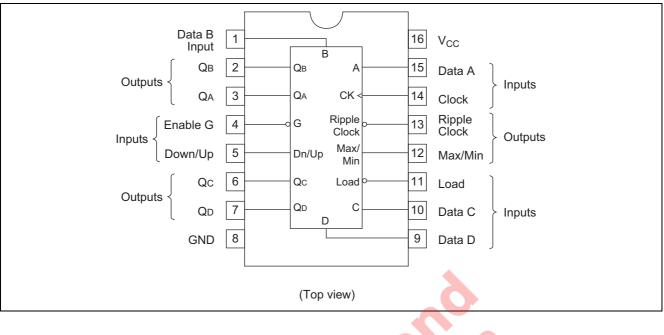
• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS190P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	—
HD74LS190FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)

Notes: Please consult the sales office for the above package availability.

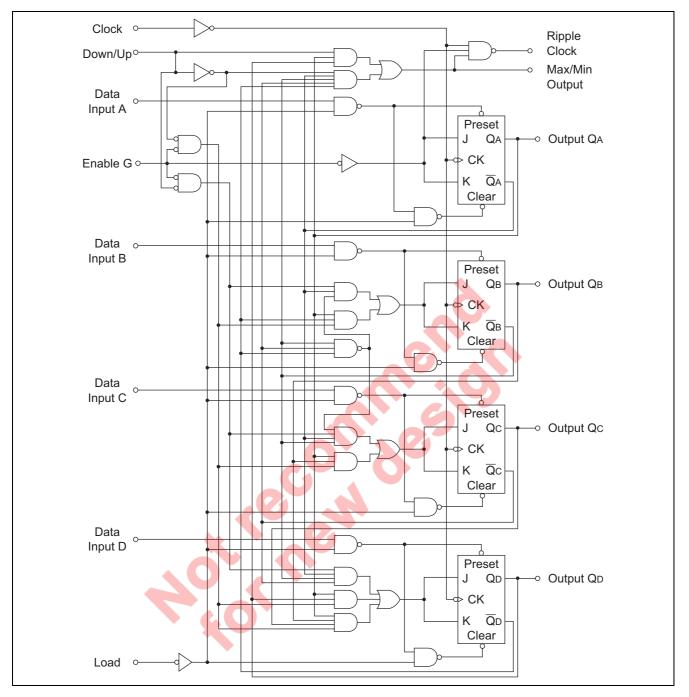


Pin Arrangement





Block Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	
Supply voltage	V _{CC}	7	V	
Input voltage	V _{IN}	7	V	
Power dissipation	PT	400	mW	
Storage temperature	Tstg	-65 to +150	°C	

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.



Recommended Operating Conditions

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{CC}	4.75	5.00	5.25	V
Output current	I _{OH}	—	—	-400	μA
Output current	I _{OL}	—	—	8	mA
Operating temperature	T _{opr}	-20	25	75	°C
Clock frequency	f_{clock}	0	—	20	MHz
Clock pulse width	t _{w (CK)}	25	—	—	ns
Load pulse width	t _{w (Load)}	35	—	—	ns
Setup time	t _{su}	20	—	—	ns
Hold time	t _{h (data)}	3	—	—	ns
Enable time	t _{enable}	40			ns

Electrical Characteristics

(Ta = -20 to +75 °C)

lte	em	Symbol	min.	typ.*	max.	Unit	Condition		
Input voltage		VIH	2.0	-		V			
		VIL	-	-	0.8	V			
Output wells as		V _{он}	2.7			V	$\label{eq:Vcc} \begin{split} V_{CC} &= 4.75 \text{ V}, \ V_{IH} = 2 \text{ V}, \ V_{IL} = 0.8 \text{ V}, \\ I_{OH} &= -400 \ \mu \text{A} \end{split}$		
Output vol	laye	V _{OL}			0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{IH} = 2 \text{ V},$		
		V OL			0.5	v	$I_{OL} = 8 \text{ mA}$ $V_{IL} = 0.8 \text{ V}$		
	Enable	- I _{IH}			60		$V_{CC} = 5.25 \text{ V}, \text{ V}_1 = 2.7 \text{ V}$		
	Others		-	(20	μΑ	$v_{CC} = 5.25 v, v_1 = 2.7 v$		
Input	Enable	- I _{IL}	-	-	-1.2	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 0.4 \text{ V}$		
current	Others		-		-0.4		$v_{CC} = 5.25 \ v, \ v_{I} = 0.4 \ v$		
	Enable	- I _l	-		0.3	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 7 \text{ V}$		
	Others			—	0.1	III/A	$v_{CC} = 5.25 v, v_{I} = 7 v$		
Short-circu current	iit output	los	-20	-0	-100	mA	V _{CC} = 5.25 V		
Supply current**		Icc	<u> </u>	20	35	mA	V _{CC} = 5.25 V		
Input clamp voltage		VIK	—	-	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$		

Notes: $* V_{CC} = 5 V$, Ta = 25°C

** Icc is measured with all outputs open and all inputs grounded.



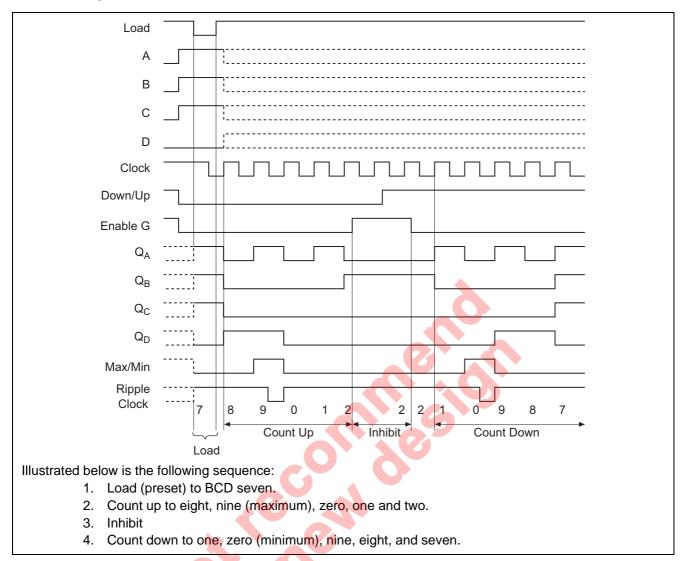
Switching Characteristics

 $(V_{CC} = 5 V, Ta = 25^{\circ}C)$

Item	Symbol	Inputs	Outputs	min.	typ.	max.	Unit	Condition
Maximum clock frequency	$f_{\sf max}$	Clock	Q _A , Q _B , Q _C , Q _D	20	25	_	MHz	
	t _{PLH}	Load Q _A , Q _B ,	Q_A, Q_B, Q_C, Q_D		22	33	ns	C _L = 15 pF, R _L = 2 kΩ
	t _{PHL}		$\mathbf{Q}_{A}, \mathbf{Q}_{B}, \mathbf{Q}_{C}, \mathbf{Q}_{D}$		33	50		
	t _{PLH}	А, В,	Q _A , Q _B , Q _C , Q _D		20	32	ns	
	t _{PHL}	C, D	$\mathbf{Q}_{A}, \mathbf{Q}_{B}, \mathbf{Q}_{C}, \mathbf{Q}_{D}$		27	40		
	t _{PLH}	Cleak	Ripple Clock		13	20	ns	
	t _{PHL}	Clock			16	24		
Propagation delay time	t _{PLH}	Clock	0 0 0		16	24	ns	
	t _{PHL}	CIUCK	Q_A, Q_B, Q_C, Q_D		24	36		
	t _{PLH}	Clock	Max / Min		28	42	ns	
	t _{PHL}	CIUCK			37	52		
	t _{PLH}	Down /	Ripple Clock		30	45	ns	
	t _{PHL}	Up			30	45		
	t _{PLH}	Down /	Max / Min		21	33	ns	
	t _{PHL}	Up		_	22	33		
	t _{PLH}	Enable	Pipple Cleck	_	21	33	00	
	t _{PHL}	LIADIE	Ripple Clock	_	22	33	ns	



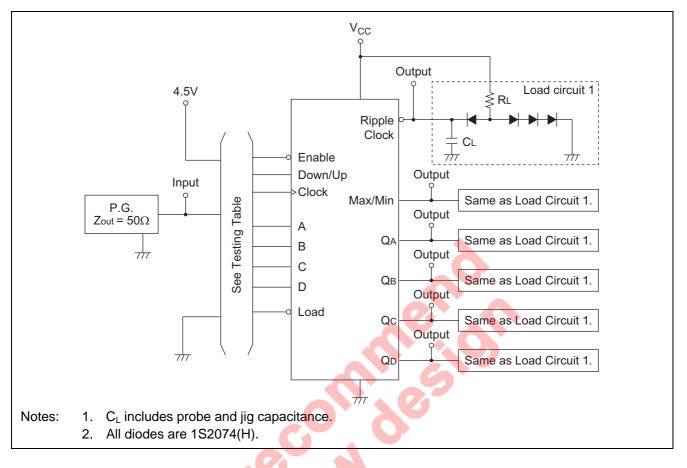
Count Sequences



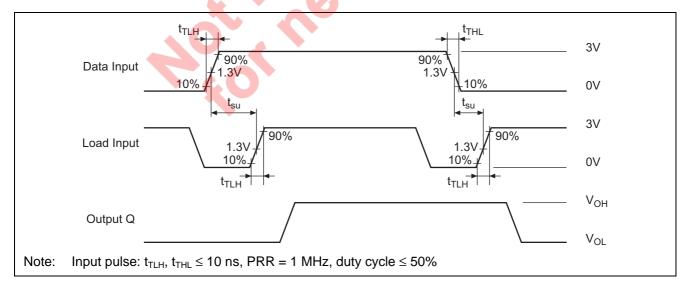


Testing Method

Test Circuit

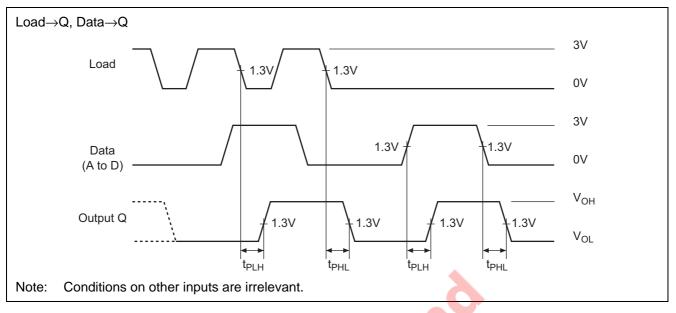


Waveforms 1

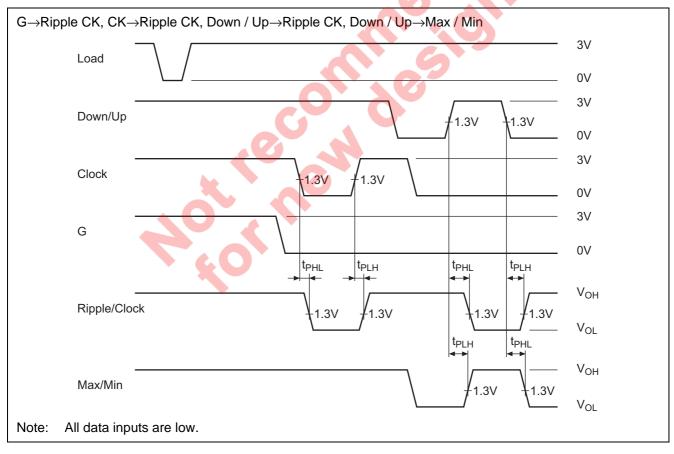


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Waveforms 2

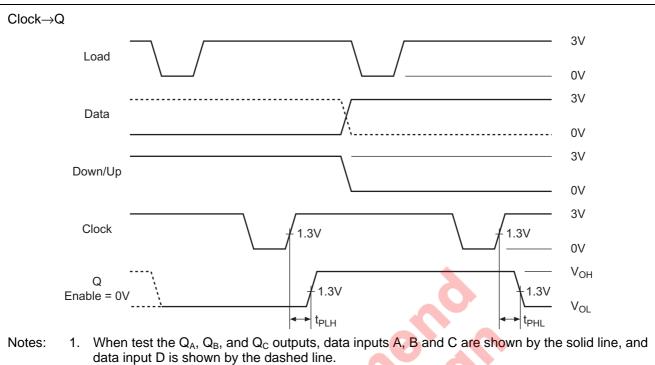


Waveforms 3



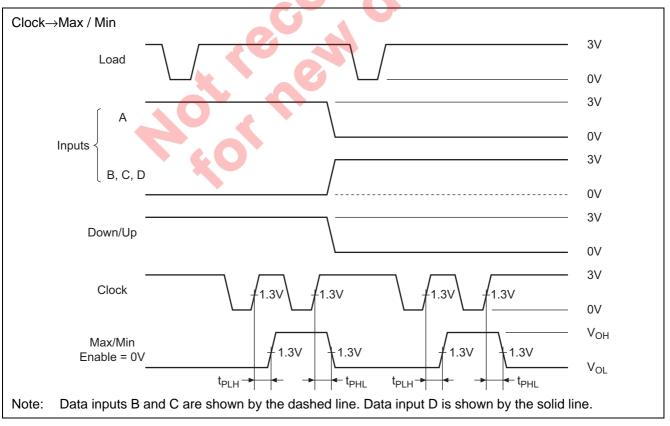
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Waveforms 4



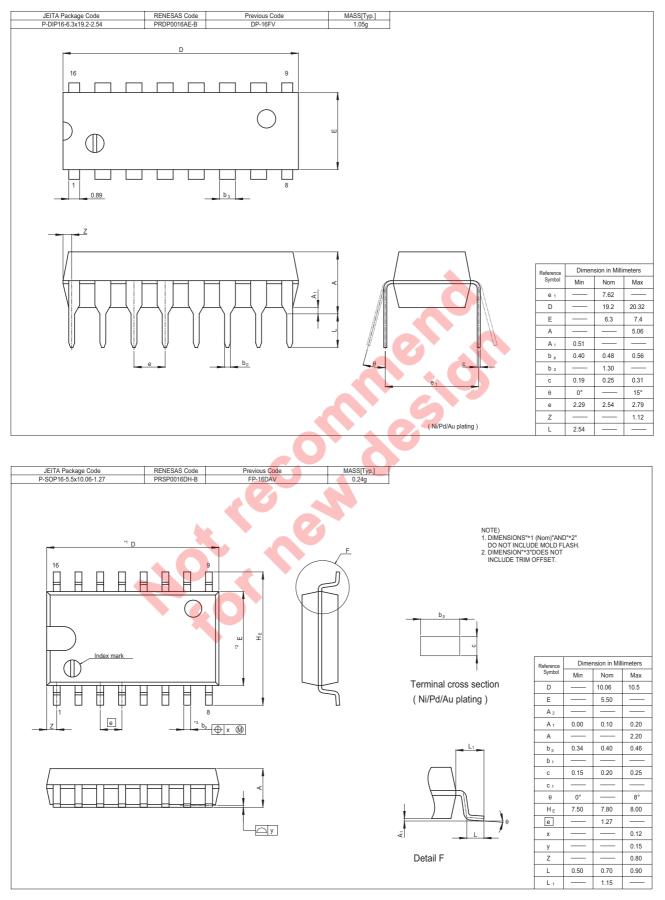
2. When test the Q_D output, data inputs A and D are shown by the solid line, and data inputs B and C are held at the low logic level.







Package Dimensions





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